## TI board Rework

The details are as follows:

- 1. Populate R317,R322 with 0 ohm resistors (footprint is 0402, 0E) Shared pad as before
- 2. Populate R316,R324 with 240 ohm resistors (footprint is 0402, 240E)
- 3. Populate R424, R420, R408, R405 with 0 ohm resistors (footprint is 0201, 0E)
- 4. Populate R76, R75, R74, R73 with 0 ohm resistors (footprint is 0402, 0E)
- 5. DNI (Remove) R232, R233, R234, R238 resistors (footprint is 0402, 49.9 E)
- 6. DNI (Remove) R205, R211, R212 resistors to disconnect from USB FTDI chip (footprint is 0402, 0E)
- 7. Populate R457, R458, R459, R460 with 0 ohm resistors (footprint is 0201, 0E)















